### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **General Description**

The MAX19757 dual-channel downconverter is designed to provide 8.8dB gain, +25.3dBm input IP3 and 10.4dB NF for a multitude of 1700MHz to 2700MHz basestation receiver applications. With an optimized LO frequency range of 1800MHz to 2600MHz, this mixer supports both high- and low-side LO injection architectures for 1700MHz to 2200MHz and 2000MHz to 2700MHz RF bands, respectively. Independent path shutdown allows the user to save DC power during low-peak usage times or in TDD TX mode.

The device integrates baluns in the RF and LO ports, an LO buffer, two double-balanced mixers, and a pair of differential IF output amplifiers. The MAX19757 requires a typical LO drive of 0dBm, and a supply current typically 300mA at band center and 350mA across the LO frequency band to achieve the targeted linearity performance.

The MAX19757 is available in a compact 36-pin TQFN package ( $6mm \times 6mm \times 0.8mm$ ) with an exposed paddle. Electrical performance is guaranteed over the extended -40°C to +105°C temperature range.

#### **Applications**

- 2.3GHz WCS Base Stations
- 2.5GHz WiMAX®, LTE, TD-LTE Base Stations
- 2.7GHz MMDS Base Stations
- UMTS/WCDMA, TD-SCDMA and cdma2000® 3G
  Base Stations
- DCS1800 and PCS1900 and EDGE Base Stations
- Fixed Broadband Wireless Access
- Wireless Local Loop
- Private Mobile Radios
- Military Systems

#### Ordering Information appears at end of data sheet.

For related parts and recommended products to use with this part, refer to <u>www.maximintegrated.com/MAX19757.related</u>.

WiMAX is a registered certification mark and registered service mark of WiMAX Forum.

cdma2000 is a registered trademark of Telecommunications Industry Association.

#### **Benefits and Features**

- 1700MHz to 2700MHz RF Frequency Range
- 1800MHz to 2600MHz LO Frequency Range
- 50MHz to 500MHz IF Frequency Range
- 25.3dBm IIP3
- 8.8dB Conversion Gain
- 13.1dBm Input 1dB Compression Point
- 10.4dB Noise Figure
- 73dBc 2RF–2LO Spurious Rejection at P<sub>RF</sub> = -10dBm
- Dual Channels Ideal for Diversity Receiver Applications
- Integrated LO Buffer
- -3dBm to +3dBm LO Drive
- Built-In SPDT LO Switch with 50dB LO-to-LO Isolation and 240ns Switching Time
- 46dB Channel Isolation
- Optional On-Chip Detector at IF Output Automatically Adjusts Bias Current for Optimum Power Management
- External Current-Setting Resistors Allow Tradeoff Between Power and Performance
- Advanced Shutdown Features Include:
  - Independent Path Power-Down
  - Rapid Power-Down/Power-Up Modes for Toggling Between On/Off States in TDD Applications
  - Controlled LO Port Impedance Minimizes VCO Pulling During Power Cycling



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#### **Absolute Maximum Ratings**

V <sub>CC</sub> 0.3V to +5.5V	RFMAIN, RFDIV, LO1, LO2 Input Power+20dBm
RFMAIN, RFDIV, LO1, LO2,	Continuous Power Dissipation (Note 1)8.7W
IFM+, IFM-, IFD+, IFD0.3V to (V <sub>CC</sub> + 0.3V)	Operating Case Temperature Range (Note 2)40°C to +105°C
IF_RADJ, LO_VADJ, LOSEL,	Maximum Junction Temperature+150°C
LO_TUNE1, LO_TUNE20.3V to (V <sub>CC</sub> + 0.3V)	Storage Temperature Range65°C to +150°C
RFMAIN to RFM_RTN, RFDIV to RFD_RTN	Lead Temperature (soldering 10s)+300°C
PD1, PD2, STBY, IF_DET_OUT,	Soldering Temperature (reflow)+260°C
IF_DET_CEXT0.3V to (V <sub>CC</sub> + 0.3V)	

**Note 1:** Based on junction temperature  $T_J = T_C + (\theta_{JC} \times V_{CC} \times I_{CC})$ . This formula can be used when the temperature of the exposed pad is known while the device is soldered down to a PCB. See the <u>Applications Information</u> section for details. The junction temperature must not exceed +150°C.

Note 2: T<sub>C</sub> is the temperature on the exposed pad of the package. T<sub>A</sub> is the ambient temperature of the device and PCB.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **Package Thermal Characteristics**

TQFN	Junction-to-Case Thermal Resistance θ <sub>JC</sub>
Junction-to-Ambient Thermal Resistance θ <sub>JA</sub>	(Notes 1, 4)+7.4°C/W
(Notes 3, 4)+36°C/W	

**Note 3:** Junction temperature  $T_J = T_A + (\theta_{JA} \times V_{CC} \times I_{CC})$ . This formula can be used when the ambient temperature of the PCB is known. The junction temperature must not exceed +150°C.

Note 4: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

#### **5V DC Electrical Characteristics**

(<u>Typical Application Circuit</u>,  $V_{CC}$  = 4.75V to 5.25V, R1 = 4.87k $\Omega$ , R3 = 154k $\Omega$  to  $V_{CC}$ , RF and IF single ended ports = 50 $\Omega$  to GND, LO1 port driven from 50 $\Omega$  source,  $P_{LO}$  = 0dBm,  $f_{LO}$  = 2350MHz, LOSEL = 5V, LO\_TUNE1 = LO\_TUNE2 = 1, PD1 = PD2 = STBY = 0,  $T_{C}$  = -40°C to +105°C. Typical values are at  $V_{CC}$  = 5.0V,  $P_{LO}$  = 0dBm,  $f_{LO}$  = 2350MHz, LO\_TUNE1 = LO\_TUNE2 = 1,  $T_{C}$  = +25°C, unless otherwise noted.) (Notes 5, 6)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	V <sub>cc</sub>		4.75	5.00	5.25	V
		f <sub>LO</sub> = 1800MHz, LO_TUNE1 = 0, LO_TUNE2 = 1		350	420	
		f <sub>LO</sub> = 1900MHz, LO_TUNE1 = 0, LO_TUNE2 = 1		324	395	
Dual-Channel Operation		f <sub>LO</sub> = 2100MHz, LO_TUNE1 = 0, LO_TUNE2 = 0		305	365	
Supply Current	DUALCH	f <sub>LO</sub> = 2300MHz, LO_TUNE1 = 1, LO_TUNE2 = 1		293	350	mA
		f <sub>LO</sub> = 2350MHz, LO_TUNE1 = 1, LO_TUNE2 = 1		290	350	
		f <sub>LO</sub> = 2500MHz, LO_TUNE1 = 1, LO_TUNE2 = 0		285	345	

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### **5V DC Electrical Characteristics (continued)**

(*Typical Application Circuit*,  $V_{CC}$  = 4.75V to 5.25V, R1 = 4.87kΩ, R3 = 154kΩ to  $V_{CC}$ , RF and IF single ended ports = 50Ω to GND, LO1 port driven from 50Ω source,  $P_{LO}$  = 0dBm,  $f_{LO}$  = 2350MHz, LOSEL = 5V, LO\_TUNE1 = LO\_TUNE2 = 1, PD1 = PD2 = STBY = 0,  $T_C$  = -40°C to +105°C. Typical values are at  $V_{CC}$  = 5.0V,  $P_{LO}$  = 0dBm,  $f_{LO}$  = 2350MHz, LO\_TUNE1 = LO\_TUNE2 = 1,  $T_C$  = +25°C, unless otherwise noted.) (Notes 5, 6)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Single-Channel Operation Supply Current	ISINGLECH	PD1 = 0, PD2 = 1 or PD1 = 1, PD2 = 1		163	197	mA
Power-Down Supply Current	I <sub>PD</sub>	PD1 = 1, PD2 = 0		5.3	8.5	mA
Standby (STBY) Supply Current	ISTBY	STBY = 1 in any power-down mode		35	49	mA
LOSEL, PD1, PD2, STBY, LO_TUNE1, LO_TUNE2, Input High Voltage	V <sub>IH</sub>		1.17			V
LOSEL, PD1, PD2, STBY LO_TUNE1, LO_TUNE2, Input Low Voltage	V <sub>IL</sub>				0.5	V
Control Logic Input Current	$I_{IL}$ and $I_{IH}$	$V_{IL} > -0.25$ ; $V_{IH} < V_{CC} + 0.25V$ ; internal 50k $\Omega$ pulldown resistors	-50		+250	μA

#### **3.3V DC Electrical Characteristics**

(*Typical Application Circuit*, V<sub>CC</sub> = 3.1V to 3.5V, R1 = 4.87kΩ, R3 = 154kΩ to V<sub>CC</sub>, RF and IF single-ended ports = 50Ω to GND, LO1 port driven from 50Ω source, P<sub>LO</sub> = 0dBm,  $f_{LO}$  = 2350MHz, LOSEL = 5V, LO\_TUNE1 = LO\_TUNE2 = 1, PD1 = PD2 = STBY = 0, T<sub>C</sub> = -40°C to +105°C. Typical values are at V<sub>CC</sub> = 3.3V, P<sub>LO</sub> = 0dBm,  $f_{LO}$  = 2350MHz, LO\_TUNE1 = LO\_TUNE2 = 1, T<sub>C</sub> = +25°C, unless otherwise noted.) (Notes 5, 6)

PARAMETER	SYMBOL	CONDITIONS		TYP	MAX	UNITS
Supply Voltage	V <sub>CC</sub>		3.1	3.3	3.5	V
Dual-Channel Operation Supply Current	IDUALCH	Total supply current		305	385	mA
Single-Channel Operation Supply Current	ISINGLECH	PD1 = 0, PD2 = 1 or PD1 = 1, PD2 = 1		163		mA
Power-Down Supply Current	I <sub>PD</sub>	PD1 = 1, PD2 = 0		3.5		mA
Standby (STBY) Supply Current	ISTBY	STBY = 1 in any power-down mode		33		mA
LOSEL, PD1, PD2, STBY, LO_TUNE1, LO_TUNE2, Input High Voltage	V <sub>IH</sub>			1.0		V
LOSEL, PD1, PD2, STBY, LO_TUNE1, LO_TUNE2, Input Low Voltage	VIL			0.75		V
Control Logic Input Current	$I_{IL}$ and $I_{IH}$	$V_{IL} > -0.25$ ; $V_{IH} < V_{CC} + 0.25V$ ; 0 to 100 internal 50kΩ pulldown resistors		μA		

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### **Recommended AC Operating Conditions**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
RF Frequency	f <sub>RF</sub>	(Note 7)	1700		2700	MHz
LO Frequency	f <sub>LO</sub>	(Note 7)	1800		2600	MHz
IF Frequency (Note 7) f <sub>IF</sub>	Using Mini-Circuits TC4-1W-17 4:1 transformer as defined in the <i>Typical</i> <i>Application Circuit</i> ; IF matching components affect the IF frequency range	100		500	MHz	
	ΊF	Using alternative Mini-Circuits TC4-1W-7A 4:1 transformer as defined in the <i>Typical Application Circuit</i> , IF matching components affect the IF frequency range	50		250	IVI IIIZ
LO Drive Level	P <sub>LO</sub>		-3		+3	dBm

#### 5V AC Electrical Characteristics (Low-Side LO)

(*Typical Application Circuit*, R1 = 4.87kΩ, R3 = 154kΩ to V<sub>CC</sub>, V<sub>CC</sub> = 4.75V to 5.25V, RF and LO ports are driven from 50Ω sources, P<sub>RF</sub> = -5dBm,  $f_{RF}$  = 2550MHz,  $f_{LO}$  = 2350MHz,  $f_{IF}$  = 200MHz,  $P_{LO1}$  = -3dBm to +3dBm, LOSEL = 1, LO\_TUNE1 = LO\_TUNE2 = 1, PD1 = PD2 = STBY = 0, T<sub>C</sub> = -40°C to +105°C. Typical values are at V<sub>CC</sub> = 5.0V, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm,  $f_{RF}$  = 2550MHz,  $f_{LO}$  = 2350MHz, LO\_TUNE1 = LO\_TUNE2 = 1,  $f_{IF}$  = 200MHz, and T<sub>C</sub> = +25°C.) (Notes 5, 6)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
Conversion Gain	C.			7.4	8.8	9.9	dB
	G <sub>C</sub>	T <sub>C</sub> = +25°C		8.1	8.8	9.7	uв
RF Gain Flatness		Flatness over any 120MHz portion of the RF band, $f_{IF}$ = 200MHz			0.10		dB
Conversion Gain Flatness	G <sub>FREQ</sub>		Flatness over a 100MHz RF band, $f_{IF} = 200 \pm 50$ MHz (Note 9)		0.34	0.55	dB
Gain Variation Over Temperature	TC <sub>CG</sub>	$T_{\rm C}$ = -40°C to +105°C	;		-0.010		dB/°C
1σ Gain Deviation		T <sub>C</sub> = -40°C to +105°C	;		0.082		dB
Input 1dB Compression Point	IP <sub>1dB</sub>	(Notes 8, 9)	(Notes 8, 9)		13.1		dBm
Output 1dB Compression Point	OP <sub>1dB</sub>	(Notes 8, 9)		17	20.9		dBm
Input 0.1dB Compression Point	IP <sub>0.1dB</sub>	(Note 9)		4	5.6		dBm
Small-Signal Compression Under Blocking Conditions		P <sub>RF</sub> = -5dBm, f <sub>BLOCk</sub> P <sub>BLOCKER</sub> = 8dBm (f			0.4		dB
Insuit Third Order Intercent Daint	1102	$f_{RF1}-f_{RF2} = 1MHz$	T <sub>C</sub> = +25°C	23.9	25.3		dBm
Input Third-Order Intercept Point	IIP3	P <sub>RF</sub> = -5dBm/tone (Notes 9,10)		23.5	25.3		abm
Input Third-Order Intercept Point 1σ Deviation	IIP3 <sub>dev</sub>	f <sub>RF1</sub> -f <sub>RF2</sub> = 1MHz, P <sub>F</sub>	<sub>RF</sub> = -5dBm/tone		0.17		dBm
Input Third-Order Intercept Point Variation Over Temperature	TC <sub>IIP3</sub>	$f_{RF1}-f_{RF2} = 1MHz$ , $P_{RF} = -5dBm/tone$ , $T_{C} = -40^{\circ}C$ to +105°C			0.0035		dB/°C
Output Third-Order Intercept	OIP3	$f_{RF1}-f_{RF2} = 1MHz$ , $T_C = +25^{\circ}C$		30.8	34.1		dBm
Point	OF 5	P <sub>RF</sub> = -5dBm/tone (Notes 9, 10)		30.4	34.1		GDIII

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### 5V AC Electrical Characteristics (Low-Side LO) (continued)

 $(Typical Application Circuit, R1 = 4.87k\Omega, R3 = 154k\Omega$  to V<sub>CC</sub>, V<sub>CC</sub> = 4.75V to 5.25V, RF and LO ports are driven from 50Ω sources, P<sub>RF</sub> = -5dBm, f<sub>RF</sub> = 2550MHz, f<sub>LO</sub> = 2350MHz, f<sub>IF</sub> = 200MHz, P<sub>LO1</sub> = -3dBm to +3dBm, LOSEL = 1, LO\_TUNE1 = LO\_TUNE2 = 1, PD1 = PD2 = STBY = 0, T<sub>C</sub> = -40°C to +105°C. Typical values are at V<sub>CC</sub> = 5.0V, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm, f<sub>RF</sub> = 2550MHz, f<sub>LO</sub> = 2350MHz, LO\_TUNE1 = LO\_TUNE2 = 1, f<sub>IF</sub> = 200MHz, and T<sub>C</sub> = +25°C.) (Notes 5, 6)

PARAMETER	SYMBOL	CONE	DITIONS	MIN	TYP	MAX	UNITS
Noise Figure, Single Sideband	NF <sub>SSB</sub>	T <sub>C</sub> = +25°C, no block de-embedded	kers present, RF trace		10.4	10.9	dB
(Note 9)	IN SSB	No blockers present, embedded, $T_C = -40^\circ$			10.4	12.2	dD
Noise Figure Temperature Coefficient	TC <sub>NF</sub>		Single sideband, no blockers present, T <sub>C</sub> = -40°C to +105°C		0.0166		dB/°C
1σ NF deviation	NF <sub>STD</sub>				0.09		dB
Noise Figure with Blocker	NFB	$\label{eq:pblocker} \begin{array}{l} P_{BLOCKER} = 8dBm, \ f_{BLOCKER} = 2300 MHz, \\ f_{RF} = 2200 MHz, \ f_{LO} = 1950 MHz, \\ f_{IFDESIRED} = 250 MHz, \ f_{IFBLOCKER} = \\ 350 MHz \ P_{LO} = 0 dBm, \ V_{CC} = 5.0 V, \\ T_{C} = +25^{\circ} C \ (Notes \ 9, \ 11) \end{array}$			18.3	20	dB
			P <sub>RF</sub> = -10dBm	63	73		
2RF - 2LO Spur Rejection (Note 9)	2 x 2	f <sub>SPUR</sub> = f <sub>LO</sub> + 100MHz	P <sub>RF</sub> = -5dBm (Note 10)	58	68		dBc
			P <sub>RF</sub> = -10dBm	75	91		
3RF - 3LO Spur Rejection (Note 9)	3 x 3	f <sub>SPUR</sub> = f <sub>LO</sub> + 66.667MHz	P <sub>RF</sub> = -5dBm (Note 10)	65	81		dBc
LO Leakage at RF Port		P <sub>LO</sub> = 3dBm (Note 9)	)		-39.8	-34	dBm
2LO Leakage at RF Port		P <sub>LO</sub> = 3dBm (Note 9)	)		-24.3	-20	dBm
3LO Leakage at RF Port		P <sub>LO</sub> = 3dBm (Note 9)	)		-46	-40	dBm
4LO Leakage at RF Port		P <sub>LO</sub> = 3dBm (Note 9)	)		-31	-22	dBm
LO Leakage at IF Port		P <sub>LO</sub> = 3dBm (Notes 9	9, 10)		-25.5	-23	dBm
LO Leakage at IF Port		$P_{LO}$ = 3dBm, $F_{LO}$ = 2	2150MHz <sub>,</sub> (Note 10)		-19.9		dBm
2LO Leakage at IF Port		P <sub>LO</sub> = 3dBm			-37		dBm
RF to IF Isolation		(Notes 9, 10)		30	37.3		dB
LO1 to LO2 Isolation		P <sub>LO1</sub> = 3dBm, P <sub>LO2</sub> 1MHz, P <sub>RF</sub> = -5dBm		30	50		dB
Channel-to-Channel Isolation		$P_{RF}$ = -10dBm, RFMAIN (RFDIV) power measured at IFDIV (IFMAIN), relative to IFMAIN (IFDIV), all unused ports terminated to 50 $\Omega$ (Notes 9, 10)		40	46		dB
LO Switching Time		50% of LOSEL to IF s degrees	settled within two		0.24		μs
Power-Down IF Attenuation		0dBm at RF & LO po reduction from PD1 a 0 to 1	rts; IF output power and PD2 switched from	40	61		dB

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### **5V AC Electrical Characteristics (Low-Side LO) (continued)**

(*Typical Application Circuit*, R1 = 4.87kΩ, R3 = 154kΩ to V<sub>CC</sub>, V<sub>CC</sub> = 4.75V to 5.25V, RF and LO ports are driven from 50Ω sources, P<sub>RF</sub> = -5dBm, f<sub>RF</sub> = 2550MHz, f<sub>LO</sub> = 2350MHz, f<sub>IF</sub> = 200MHz, P<sub>LO1</sub> = -3dBm to +3dBm, LOSEL = 1, LO\_TUNE1 = LO\_TUNE2 = 1, PD1 = PD2 = STBY = 0, T<sub>C</sub> = -40°C to +105°C. Typical values are at V<sub>CC</sub> = 5.0V, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm, f<sub>RF</sub> = 2550MHz, f<sub>LO</sub> = 2350MHz, LO\_TUNE1 = LO\_TUNE2 = 1, f<sub>IF</sub> = 200MHz, and T<sub>C</sub> = +25°C.) (Notes 5, 6)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Power-Down Time		PD1 and PD2 switched from 0 to 1. Settled to within 5% of the final power down DC current.		20		ns	
Power-Down Recovery Time		PD1 and PD2 switched from 1 to 0. The 'on' state is defined as IF phase settled to within $< \pm 1^{\circ}$ of the final value in a static measurement.		0.55		μs	
STBY Time		STBY switched from 0 to 1. Settled to within 5% of the final shutdown DC current.		20			
STBY Recovery Time		STBY switched from 1 to 0. The 'on' state is defined as IF phase settled to within $< \pm 1^{\circ}$ of the final value in a static measurement.	0.5		μs		
RF Input Impedance	Z <sub>RF</sub>			50		Ω	
RF Return Loss		LO on and IF terminated		20		dB	
LO Input Impedance	Z <sub>LO</sub>			50		Ω	
LO Return Loss		LO port selected		16		dB	
LO Return Loss		LO port unselected		17			
IF Output Impedance	Z <sub>IF</sub>	Nominal differential impedance at the IC's IF outputs	200		Ω		
IF Return Loss		RF terminated into $50\Omega$ , LO driven by $50\Omega$ source, IF transformed to $50\Omega$ using external components shown in the <i>Typical Application Circuit</i>		30		dB	

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### **5V AC Electrical Characteristics (High-Side LO)**

(*Typical Application Circuit*, R1 = 4.87kΩ, R3 = 154kΩ to V<sub>CC</sub>, V<sub>CC</sub> = 4.75V to 5.25V, RF and LO ports are driven from 50Ω sources, P<sub>LO1</sub> = -3dBm to +3dBm, P<sub>RF</sub> = -5dBm, f<sub>RF</sub> = 2150MHz, f<sub>LO</sub> = 2350MHz, f<sub>IF</sub> = 200MHz, LOSEL = 1, LO\_TUNE1 = LO\_TUNE2 = 1, PD1 = PD2 = STBY = 0, T<sub>C</sub> = -40°C to +105°C. Typical values are at V<sub>CC</sub> = 5.0V, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm, f<sub>RF</sub> = 2150MHz, f<sub>LO</sub> = 2350MHz, LO\_TUNE1 = LO\_TUNE2 = 1, f<sub>IF</sub> = 200MHz, and T<sub>C</sub> = +25°C.) (Notes 5, 6)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
0	-			7.7	9.2	10.2	JD
Conversion Gain	G <sub>C</sub>	T <sub>C</sub> = +25°C		8.4	9.2	10.1	dB
RF Gain Flatness		Flatness over any 120 band, f <sub>IF</sub> = 200MHz	OMHz portion of the RF		0.10		dB
Conversion Gain Flatness	G <sub>FREQ</sub>	Flatness over a 100M f <sub>IF</sub> = 200 ±50MHz	IHz RF band,		0.4		dB
Gain Variation Over Temperature	TC <sub>CG</sub>	$T_{\rm C}$ = -40°C to +105°C	;		-0.010		dB/°C
1σ Gain Deviation					0.08		dB
Input 1dB Compression Point	IP <sub>1dB</sub>	(Notes 8, 9)		10.3	12.6		dBm
Output 1dB Compression Point	OP <sub>1dB</sub>	(Notes 8, 9)		17.0	20.8		dBm
Input 0.1dB Compression Point	IP <sub>0.1dB</sub>				7.1		dBm
Small-Signal Compression Under Blocking Conditions		P <sub>RF</sub> = -5dBm, f <sub>BLOCk</sub> P <sub>BLOCKER</sub> = 8dBm (f			0.4		dB
Input Third-Order Intercept Point	IIP3	f <sub>RF1</sub> - f <sub>RF2</sub> = 1MHz, F	P <sub>RF</sub> = -5dBm/tone		24.7		dBm
Input Third-Order Intercept Point 1σ Deviation	IIP3 <sub>dev</sub>	f <sub>RF1</sub> - f <sub>RF2</sub> = 1MHz, F		0.15		dBm	
Input Third-Order Intercept Point Variation Over Temperature	TC <sub>IIP3</sub>	f <sub>RF1</sub> - f <sub>RF2</sub> = 1MHz, F T <sub>C</sub> = -40°C to +105°C		-0.01		dB/°C	
Output Third-Order Intercept Point	OIP3	f <sub>RF1</sub> - f <sub>RF2</sub> = 1MHz, F	P <sub>RF</sub> = -5dBm/tone		34		dBm
Noise Figure, Single Sideband	NF <sub>SSB</sub>	No blockers present			10.0		dB
Noise Figure Temperature Coefficient	TC <sub>NF</sub>	Single sideband, no b T <sub>C</sub> = -40°C to +105°C			0.017		dB/°C
Noise Figure with Blocker	NFB	$\label{eq:BLOCKER} \begin{array}{l} P_{BLOCKER} = 8 \text{dBm, f} \\ f_{RF} = 2050 \text{MHz, f}_{LO} = \\ f_{IFDESIRED} = 250 \text{MHz} \\ 350 \text{MHz} \mbox{(Note 11)} \end{array}$			18.4		dB
2LO 2DE Spur Dejection	2 2 2	f <sub>SPUR</sub> = f <sub>LO</sub> -	P <sub>RF</sub> = -10dBm		85		dBc
2LO – 2RF Spur Rejection	2 x 2	100MHz	P <sub>RF</sub> = -5dBm		80		dBc
2LO 2DE Cour Dejection	2 4 2	f <sub>SPUR</sub> = f <sub>LO</sub> -	P <sub>RF</sub> = -10dBm		85.5		dBc
3LO – 3RF Spur Rejection	3 x 3	$\begin{array}{c} 66.667 \text{MHz} \\ \end{array} \qquad \begin{array}{c} \text{R} \\ \text{P}_{\text{RF}} = -5 \text{dBm} \\ \end{array}$			75.5		dBc
LO Leakage at RF Port		P <sub>LO</sub> = 3dBm			-40		dBm
2LO Leakage at RF Port		P <sub>LO</sub> = 3dBm			-24		dBm
3LO Leakage at RF Port		P <sub>LO</sub> = 3dBm			-40		dBm
4LO Leakage at RF Port		P <sub>LO</sub> = 3dBm			-30		dBm
LO Leakage at IF Port		P <sub>LO</sub> = 3dBm (Note 10	))		-25.5		dBm
2LO Leakage at IF Port		P <sub>LO</sub> = 3dBm			-37		dBm

### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

### **5V AC Electrical Characteristics (High-Side LO) (continued)**

(*Typical Application Circuit*, R1 = 4.87kΩ, R3 = 154kΩ to V<sub>CC</sub>, V<sub>CC</sub> = 4.75V to 5.25V, RF and LO ports are driven from 50Ω sources, P<sub>LO1</sub> = -3dBm to +3dBm, P<sub>RF</sub> = -5dBm, f<sub>RF</sub> = 2150MHz, f<sub>LO</sub> = 2350MHz, f<sub>IF</sub> = 200MHz, LOSEL = 1, LO\_TUNE1 = LO\_TUNE2 = 1, PD1 = PD2 = STBY = 0, T<sub>C</sub> = -40°C to +105°C. Typical values are at V<sub>CC</sub> = 5.0V, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm, f<sub>RF</sub> = 2150MHz, f<sub>LO</sub> = 2350MHz, LO\_TUNE1 = LO\_TUNE2 = 1, f<sub>IF</sub> = 200MHz, and T<sub>C</sub> = +25°C.) (Notes 5, 6)

PARAMETER	PARAMETER SYMBOL CONDITIONS		MIN	TYP	MAX	UNITS
RF to IF Isolation		(Note 10)		34		dB
LO1 to LO2 Isolation		$P_{LO1}$ = 3dBm, $P_{LO2}$ = 3dBm, f <sub>LO1</sub> - f <sub>LO2</sub> = 1MHz, $P_{RF}$ = -5dBm (Note 12)		50		dB
Channel-to-Channel Isolation		$P_{RF}$ = -10dBm, RFMAIN (RFDIV) power measured at IFDIV (IFMAIN), relative to IFMAIN (IFDIV), all unused ports terminated to 50 $\Omega$ , (Note 10)		50		dB
LO Switching Time		50% of LOSEL to IF settled within two degrees		0.24		μs
Power-Down IF Attenuation		0dBm at RF & LO ports; IF output power reduction from PD1 and PD2 switched from 0 to 1	40	61		dB
Power-Down Time		PD1 and PD2 switched from 0 to 1. Settled to within 5% of the final power down DC current.		20		ns
Power-Down Recovery Time		PD1 and PD2 switched from 1 to 0. The 'on' state is defined as IF phase settled to within $< \pm 1^{\circ}$ of the final value in a static measurement.		0.55		μs
STBY Time		STBY switched from 0 to 1. Settled to within 5% of the final shutdown DC current.		20		ns
STBY Recovery Time		STBY switched from 1 to 0. The 'on' state is defined as IF phase settled to within $< \pm 1^{\circ}$ of the final value in a static measurement.		0.5		μs
RF Input Impedance	Z <sub>RF</sub>			50		Ω
RF Return Loss		LO on and IF terminated		20		dB
LO Input Impedance	Z <sub>LO</sub>			50		Ω
LO Return Loss		LO port selected		16		dB
		LO port unselected		17		
IF Output Impedance	Z <sub>IF</sub>	Nominal differential impedance at the IC's IF outputs		200		Ω
IF Return Loss		RF terminated into $50\Omega$ , LO driven by $50\Omega$ source, IF transformed to $50\Omega$ using external components shown in the <i>Typical Application Circuit</i> .		30		dB

# Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### 3.3V AC Electrical Characteristics (Low-Side LO)

(*Typical Application Circuit*, R1 = 4.87kΩ, R3 = 154kΩ to V<sub>CC</sub>, RF and LO ports are driven from 50Ω sources. Typical values are at V<sub>CC</sub> = 5.0V, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm, f<sub>RF</sub> = 2550MHz, f<sub>LO</sub> = 2350MHz, f<sub>IF</sub> = 200MHz LO\_TUNE1 = LO\_TUNE2 = 1, PD1 = PD = STBY = 0, and T<sub>C</sub> = +25°C.) (Note 6)

PARAMETER	SYMBOL	CONE	DITIONS	MIN	TYP	MAX	UNITS
Conversion Gain	G <sub>C</sub>				8.9		dB
Gain Variation Over Temperature	TC <sub>CG</sub>	T <sub>C</sub> = -40°C to +105°C	C		0.011		dB/°C
Input 1dB Compression Point	IP <sub>1dB</sub>	(Note 8)			10.2		dBm
Output 1dB Compression Point	OP <sub>1dB</sub>	(Note 8)		18.1		dBm	
Input Third-Order Intercept Point	IIP3	f <sub>RF1</sub> - f <sub>RF2</sub> = 1MHz, P <sub>RF</sub> = -5dBm/tone			24.1		dBm
Output Third-Order Intercept Point	OIP3	f <sub>RF1</sub> - f <sub>RF2</sub> =1MHz, P	<sub>RF</sub> = -5dBm/tone		33		dBm
Noise Figure, Single Sideband	NF <sub>SSB</sub>	No blockers present, embedded	RF trace de-		10.3		dB
2RF - 2LO Spur Rejection	2 x 2	$f_{SPUR} = f_{LO} + P_{RF} = -10dBm$			71		dBc
	2.8.2	100MHz	P <sub>RF</sub> = -5dBm		66		dBc
3RF - 3LO Spur Rejection	3 x 3	f <sub>SPUR</sub> = f <sub>LO</sub> +	P <sub>RF</sub> = -10dBm		82		dBc
	3.7.3	66.667MHz	P <sub>RF</sub> = -5dBm		72		dBc
LO Leakage at RF Port		P <sub>LO</sub> = 3dBm		-36.6		dBm	
2LO Leakage at RF Port		P <sub>LO</sub> = 3dBm		-22.6		dBm	
LO Leakage at IF Port		P <sub>LO</sub> = 3dBm		-26.3		dBm	
RF to IF Isolation					35.6		dB
Channel-to-Channel Isolation		$P_{RF}$ = -10dBm, RFM measured at IFDIV (I IFMAIN (IFDIV), all u to 50 $\Omega$			45.6		dB
LO Switching Time		50% of LOSEL to IF s degrees	settled within two		0.24		us
RF Input Impedance	Z <sub>RF</sub>				50		Ω
RF Return Loss		LO on and IF termina	ated		20		dB
LO Input Impedance	Z <sub>LO</sub>				50		Ω
		LO port selected			16		dD
LO Return Loss		LO port unselected	•		17		dB
IF Output Impedance	Z <sub>IF</sub>	Nominal differential impedance at the IC's IF outputs			200		Ω
IF Return Loss		RF terminated into 50Ω, LO driven by         50Ω source, IF transformed to 50Ω using         external components shown in the Typical         Application Circuit.			30		dB

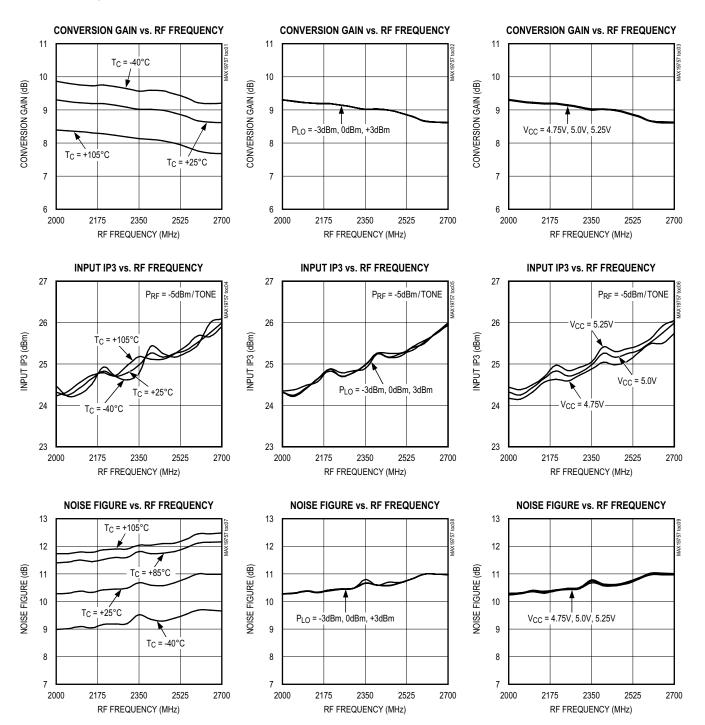
### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

- **Note 5:** Production tested and guaranteed at  $T_C = +25^{\circ}C$  for worst-case supply voltage. Performance at  $T_C = -40^{\circ}C$  and  $+105^{\circ}C$  are guaranteed by production test characterization.
- Note 6: All limits reflect 0.35dB loss for RF connectors and PCB RF trace, and 0.7dB loss for the IF transformer unless otherwise noted .Output measurements taken at IF outputs with the *Typical Application Circuit*.
- **Note 7:** Not production tested. Operation outside this range is possible, but with degraded performance of some parameters. See *Typical Operating Characteristics*.
- Note 8: Maximum reliable continuous input power applied to the RF or LO port of this device is 15dBm from a 50Ω source.
- Note 9: Guaranteed by design and characterization. GBDC limits are 6-sigma.
- Note 10: 100% production tested for functionality.
- Note 11: Measured with external LO source noise filtered so the noise floor is -174dBm/Hz. This specification reflects the effects of all SNR degradations in the mixer, including the LO noise as defined in Maxim Application Note 2021: Specifications and Measurement of Local Oscillator Noise in Integrated Circuit Base Station Mixers.
- Note 12: Measured at IF port at IF frequency. LOSEL may be in either logic state.

### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics**

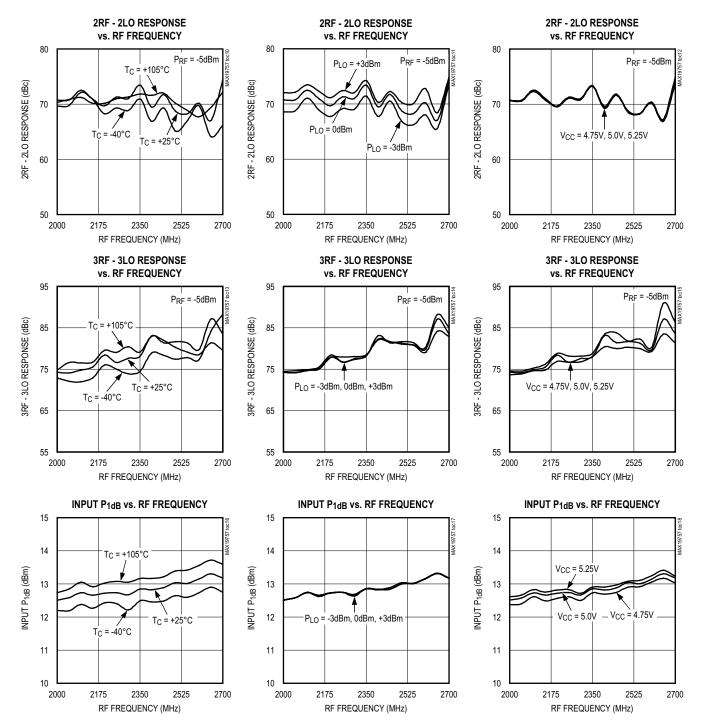
(*Typical Application Circuit*, V<sub>CC</sub> = 5.0V,  $f_{RF}$  = 2000MHz to 2700MHz, LO is low-side injected for a 200MHz IF, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm, T<sub>C</sub> = +25°C, LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)



### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

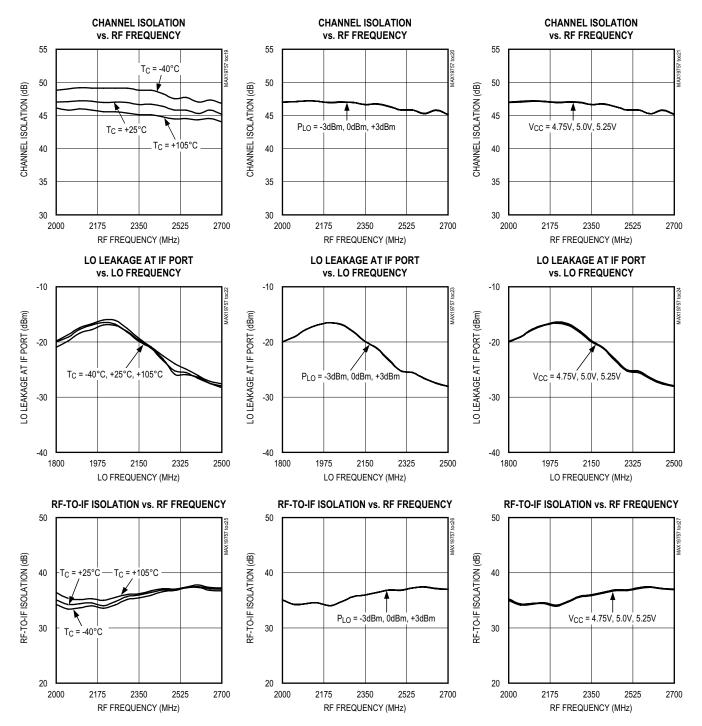
(*Typical Application Circuit*,  $V_{CC} = 5.0V$ ,  $f_{RF} = 2000MHz$  to 2700MHz, LO is low-side injected for a 200MHz IF,  $P_{RF} = -5dBm$ ,  $P_{LO} = 0dBm$ ,  $T_{C} = +25^{\circ}C$ , LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)



### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

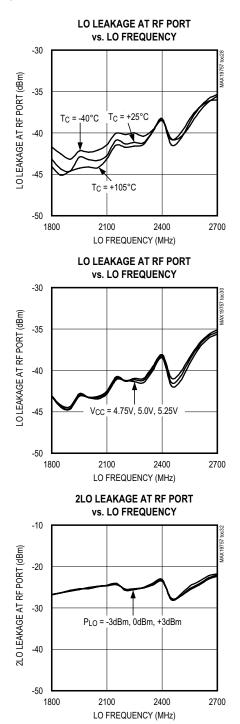
(*Typical Application Circuit*,  $V_{CC} = 5.0V$ ,  $f_{RF} = 2000MHz$  to 2700MHz, LO is low-side injected for a 200MHz IF,  $P_{RF} = -5dBm$ ,  $P_{LO} = 0dBm$ ,  $T_{C} = +25^{\circ}C$ , LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)

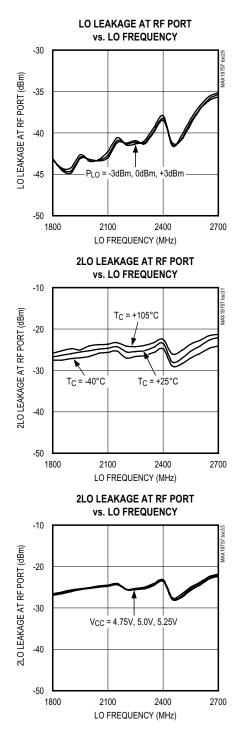


### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

(*Typical Application Circuit*,  $V_{CC}$  = 5.0V,  $f_{RF}$  = 2000MHz to 2700MHz, LO is low-side injected for a 200MHz IF,  $P_{RF}$  = -5dBm,  $P_{LO}$  = 0dBm,  $T_{C}$  = +25°C, LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)

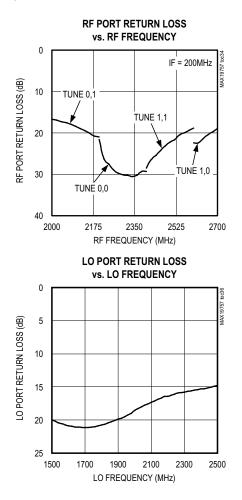


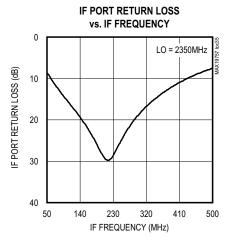


### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

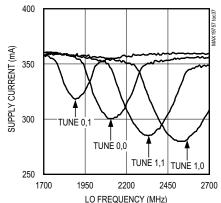
#### **Typical Operating Characteristics (continued)**

(*Typical Application Circuit*,  $V_{CC}$  = 5.0V,  $f_{RF}$  = 2000MHz to 2700MHz, LO is low-side injected for a 200MHz IF,  $P_{RF}$  = -5dBm,  $P_{LO}$  = 0dBm,  $T_{C}$  = +25°C, LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)





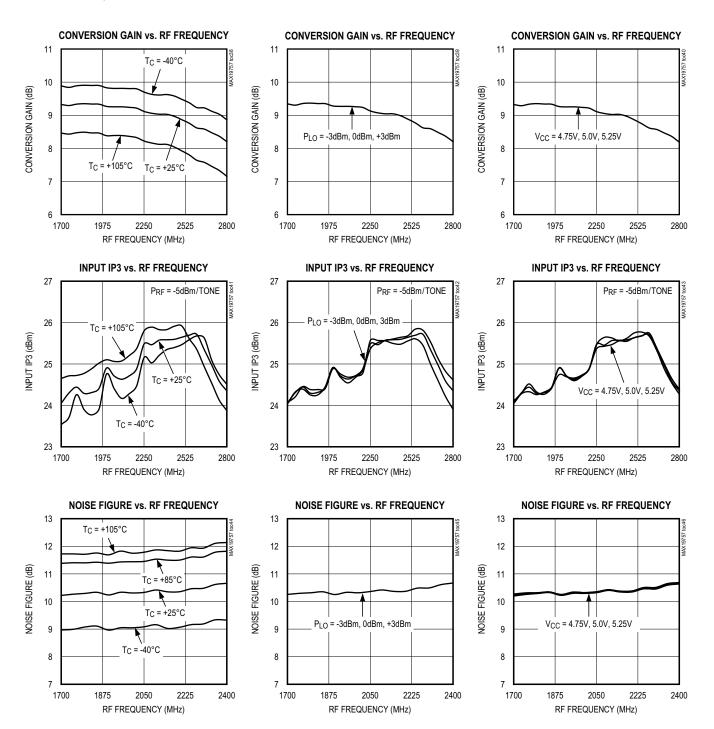
SUPPLY CURRENT vs. LO FREQUENCY



### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

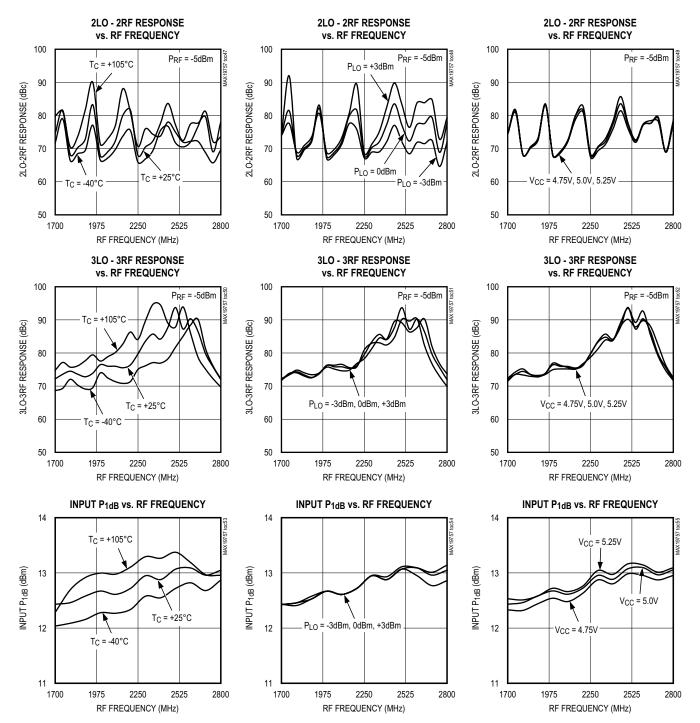
(*Typical Application Circuit*, V<sub>CC</sub> = 5.0V,  $f_{RF}$  = 1700MHz to 2800MHz, LO is high-side injected for a 200MHz IF, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm, T<sub>C</sub> = +25°C, LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)



### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

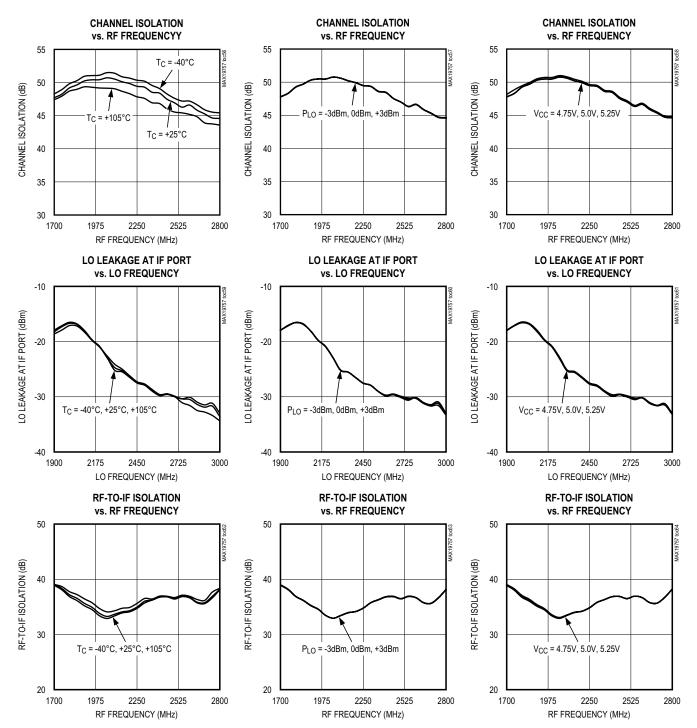
(*Typical Application Circuit*, V<sub>CC</sub> = 5.0V,  $f_{RF}$  = 1700MHz to 2800MHz, LO is high-side injected for a 200MHz IF, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm, T<sub>C</sub> = +25°C, LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)



### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

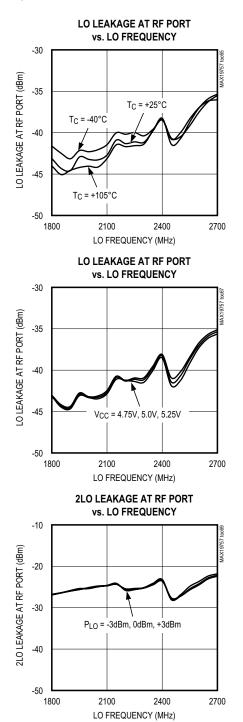
(*Typical Application Circuit*,  $V_{CC} = 5.0V$ ,  $f_{RF} = 1700MHz$  to 2800MHz, LO is high-side injected for a 200MHz IF,  $P_{RF} = -5dBm$ ,  $P_{LO} = 0dBm$ ,  $T_{C} = +25^{\circ}C$ , LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)

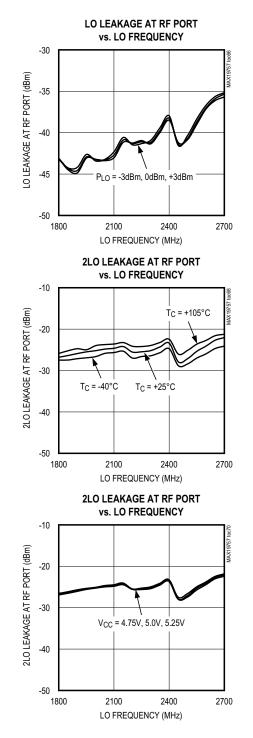


### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

(*Typical Application Circuit*, V<sub>CC</sub> = 5.0V,  $f_{RF}$  = 1700MHz to 2800MHz, LO is high-side injected for a 200MHz IF, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm, T<sub>C</sub> = +25°C, LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)

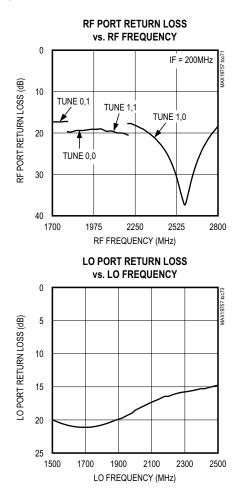


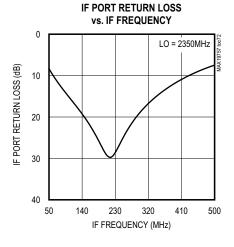


### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

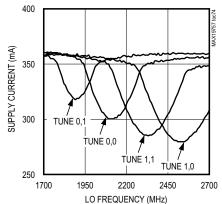
#### **Typical Operating Characteristics (continued)**

(*Typical Application Circuit*, V<sub>CC</sub> = 5.0V,  $f_{RF}$  = 1700MHz to 2800MHz, LO is high-side injected for a 200MHz IF,  $P_{RF}$  = -5dBm,  $P_{LO}$  = 0dBm,  $T_{C}$  = +25°C, LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)





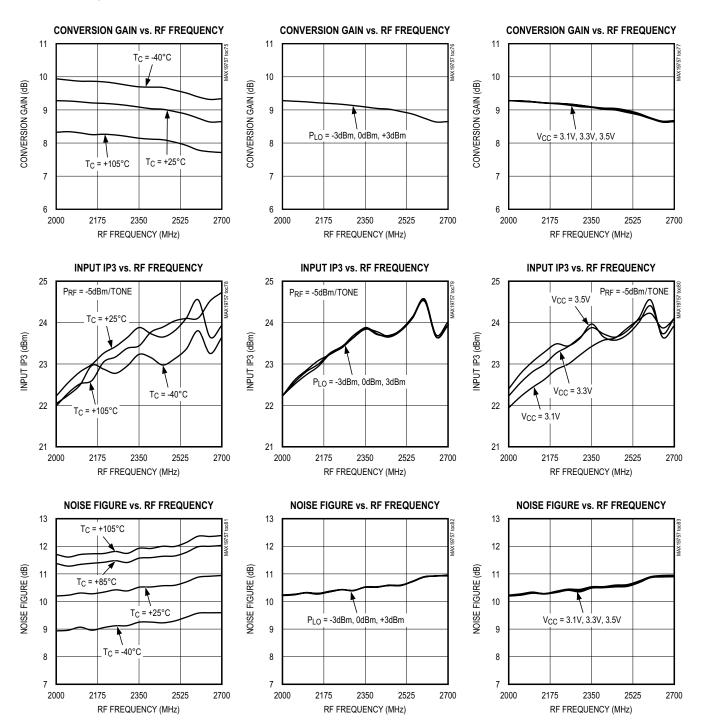
SUPPLY CURRENT vs. LO FREQUENCY



### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

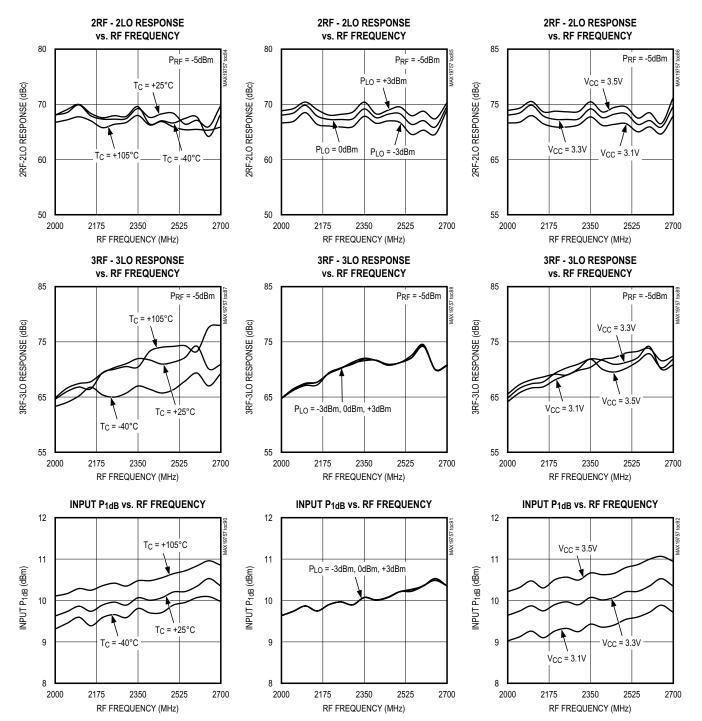
(*Typical Application Circuit*,  $V_{CC}$  = 3.3V,  $f_{RF}$  = 2000MHz to 2700MHz, LO is low-side injected for a 200MHz IF,  $P_{RF}$  = -5dBm,  $P_{LO}$  = 0dBm,  $T_{C}$  = +25°C, LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)



### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

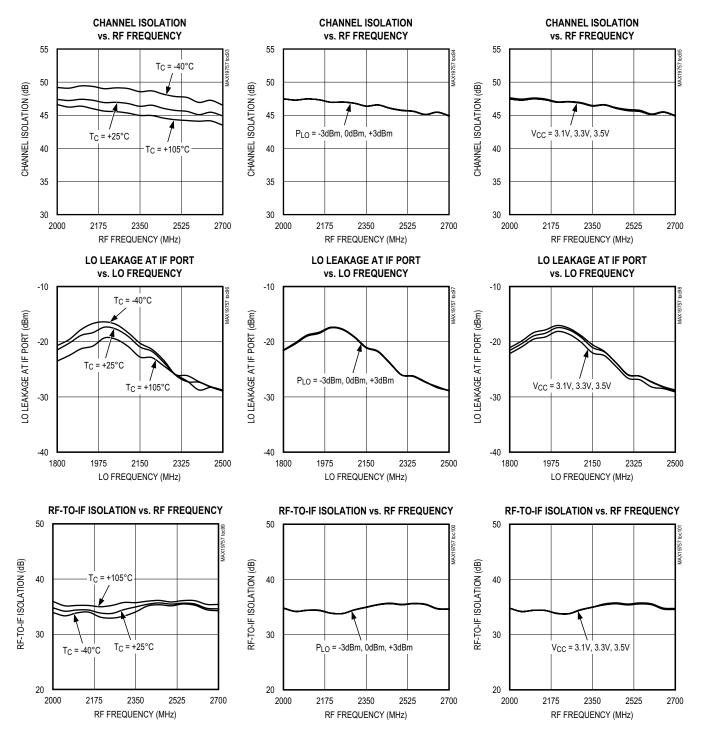
(*Typical Application Circuit*,  $V_{CC} = 3.3V$ ,  $f_{RF} = 2000MHz$  to 2700MHz, LO is low-side injected for a 200MHz IF,  $P_{RF} = -5dBm$ ,  $P_{LO} = 0dBm$ ,  $T_{C} = +25^{\circ}C$ , LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)



### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

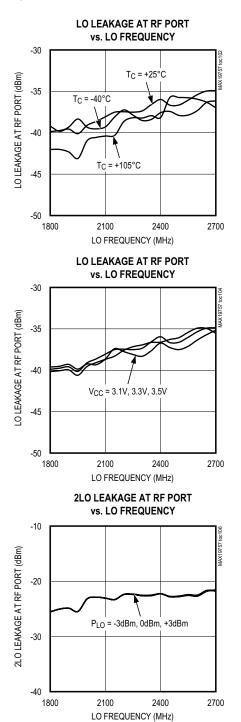
(*Typical Application Circuit*,  $V_{CC} = 3.3V$ ,  $f_{RF} = 2000MHz$  to 2700MHz, LO is low-side injected for a 200MHz IF,  $P_{RF} = -5dBm$ ,  $P_{LO} = 0dBm$ ,  $T_{C} = +25^{\circ}C$ , LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)

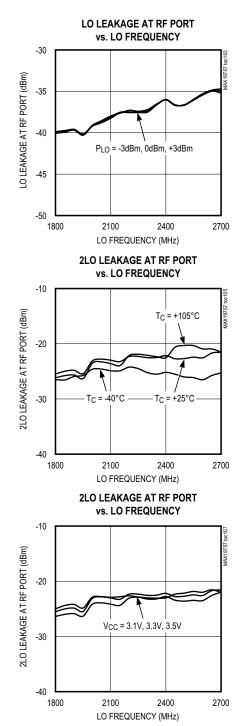


### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Typical Operating Characteristics (continued)**

(*Typical Application Circuit*,  $V_{CC}$  = 3.3V,  $f_{RF}$  = 2000MHz to 2700MHz, LO is low-side injected for a 200MHz IF,  $P_{RF}$  = -5dBm,  $P_{LO}$  = 0dBm,  $T_{C}$  = +25°C, LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)

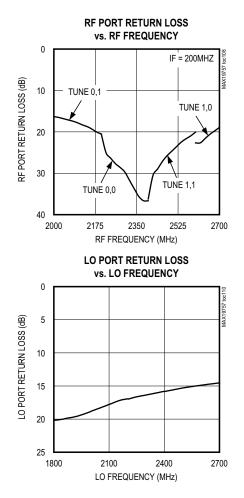


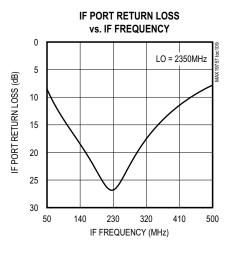


### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

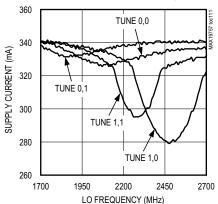
#### **Typical Operating Characteristics (continued)**

(*Typical Application Circuit*,  $V_{CC}$  = 3.3V,  $f_{RF}$  = 2000MHz to 2700MHz, LO is low-side injected for a 200MHz IF,  $P_{RF}$  = -5dBm,  $P_{LO}$  = 0dBm,  $T_{C}$  = +25°C, LO1 driven, LOSEL= 5V, STBY = PD1 = PD2 = GND, LOTUNE1 and LOTUNE2 set per <u>Table 2</u>, unless otherwise noted.)



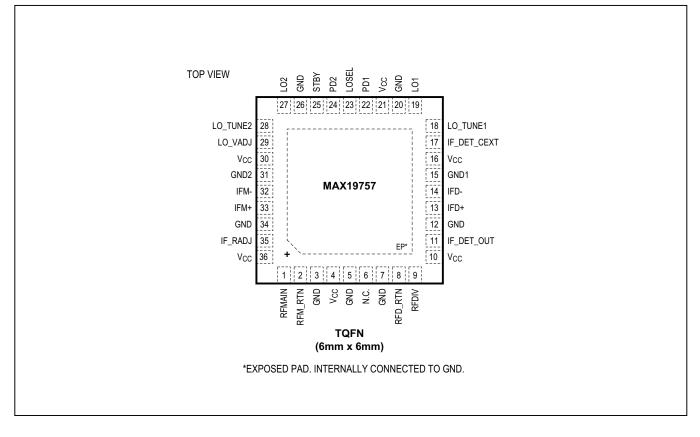


SUPPLY CURRENT vs. LO FREQUENCY



# Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

### **Pin Configuration**



# Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

### **Pin Description**

PIN	NAME	FUNCTION			
1	RFMAIN	Main Channel RF Input. Internally matched to $50\Omega$ . Requires an input DC-blocking capacitor.			
2	RFM_RTN	Main Channel RF return. Bypass to GND with capacitor close to the pin.			
3, 5, 7, 12, 20, 26, 34	GND	Ground			
4, 10, 16, 21, 30, 36	V <sub>CC</sub>	Power-Supply Input. Connect bypass capacitors as close to the pin as possible.			
6	N.C.	No Connection. This pin has no internal connection and can be left open or connected to ground.			
8	RFD_RTN	Diversity Channel RF Return. Bypass to GND with capacitor close to the pin.			
9	RFDIV	Diversity Channel RF Input. Internally matched to $50\Omega$ ; requires an input DC-blocking capacitor.			
11	IF_DET_OUT	If auto-leveling loop is not used leave this pin unconnected. If auto-leveling is desired connect resistor R2 and R3 to IF_DET_OUT and add a capacitor Cext (Pin 17) to ground (see the <i>Optional Dynamic Bias Typical Application Circuit</i> ).			
13, 14	IFD+, IFD-	Diversity Mixer Differential IF Output. Connect pullup inductors from each of these pins to V <sub>CC</sub> .			
15, 31	GND1, GND2	Connect these pins to a via to ground.			
17	IF_DET_CEXT	If auto-leveling loop is not used leave this pin unconnected. If auto leveling is used connect a capacitor to ground (see the <i>Optional Dynamic Bias Typical Application Circuit</i> ). This capacitor sets the detector decay rate.			
18, 28	LO_TUNE1, LO_TUNE2	2-Bit LO Tank Tuning. See Table 2 for desired setting internal 50k $\Omega$ pulldown resistor.			
19	LO1	Local Oscillator 1 Input. This input is internally matched to 50Ω. Requires an input DC-blocking capacitor.			
22, 24	PD1, PD2	Power-Down Control Pin Logic. See Table 1 for desired setting. Internal 50k $\Omega$ pulldown resistor.			
23	LOSEL	Local Oscillator Select Input. Set LOSEL high to select LO1. Set LOSEL low to select LO2. Interna $50k\Omega$ pulldown resistor.			
25	STBY	Standby (Active-High). All Off except Bias and selected LO port. Internal 50k $\Omega$ pulldown resistor.			
27	LO2	Local Oscillator 2 Input. This input is internally matched to $50\Omega$ . Requires an input DC-blocking capacitor.			
29	LO_VADJ	LO Drive Amplitude Bias Control. Internally biased to V <sub>REF</sub> . Connect a resistor to VCC.			
32, 33	IFM-, IFM+	Main Mixer Differential IF Output. Connect pullup inductors from each of these pins to V <sub>CC</sub> .			
35	IF _RADJ	IF Amplifier Bias Control Mode. Connect a resistor from this pin to ground to set the bias current for the IF amplifiers.			
_	EP	Exposed Pad. Internally connected to GND. Solder this exposed pad to a PCB pad that uses multiple ground vias to provide heat transfer out of the device into the PCB ground planes. These multiple via grounds are also required to achieve the noted RF performance (see the <i>Layout Considerations</i> section.)			

### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Detailed Description**

The MAX19757 dual-channel downconverter is designed to provide 8.8dB gain, 25.3dBm input IP3 and 10.4dB NF for a multitude of 1700MHz to 2700MHz basestation receiver applications. With an optimized LO frequency range of 1800MHz to 2600MHz, this mixer supports both high- and low-side LO injection architectures for 1700MHz to 2200MHz and 2000MHz to 2700MHz RF bands, respectively. Independent path shutdown allows the user to save DC power during low-peak usage times or in TDD TX mode.

The device integrates baluns in the RF and LO ports, an LO buffer, two double-balanced mixers, and a pair of differential IF output amplifiers. The MAX19757 requires a typical LO drive of 0dBm and a supply current typically 300mA at band center and 350mA across the RF frequency band to achieve the targeted linearity performance.

#### **Applications Information**

#### Independent Channel Shutdown

Control pins PD1 and PD2 can be used to *independently* enable/disable the two mixer channels. <u>Table 1</u> summarizes the relevant settings for enabling/disabling each channel. Both channels can be switched on and off in unison by tying PD2 to ground and switching PD1. The PD1 and PD2 inputs have an internal  $50k\Omega$  pulldown resistor which can be used to set a logic-low if left unconnected.

#### **LO Port Select**

As with most of Maxim's Dual Rx mixers, the MAX19757 includes an LO select control (LOSEL) for use in systems with multiple LO synthesizers. LOSEL controls the active LO port selection. Setting LOSEL high (V<sub>CC</sub>) selects LO port 1 while LOSEL low (ground) selects LO port 2. The LOSEL input has an internal 50k $\Omega$  pulldown resistor which can be used to set a logic-low if left unconnected.

# LO Buffer Standby Mode (Synthesizer Pulling Prevention Feature)

To minimize LO port disturbances in transceiver systems that reuse the LO for transmit, the active front-end circuitry of the MAX19757 LO port can be left ON while disabling the selected Rx path(s). Toggling the STBY pin high (V<sub>CC</sub>) will place the selected LO port driver in a constant ON state, ensuring a buffered termination for the external synthesizer during main and/or diversity path shutdowns. Depending on the application, this buffered interface may allow for the elimination of the external buffer that is typically used between the synthesizer and the mixers LO port. The STBY input has an internal 50k $\Omega$ 

pulldown resistor which can be used to set a logic-low if left unconnected.

#### LO Tune

The MAX19757 employs a resonant LO driver scheme for improved efficiency, as well as an internal leveling control loop (ALC) to hold the internal LO drive level constant. To extend the frequency range of this topology, two bits of tuning are used to adjust the LO tank resonance. Good efficiency is maintained over a typical ±150MHz range around the resonant frequency. Table 2 settings should be used to select the appropriate LO band for best efficiency and performance. DC currents over LO Frequency at the four tune settings can be seen in the Typical Operating Characteristics curves. The minimum bias current corresponds to the LO tank resonant point. The internal ALC loop maintains a constant drive amplitude over the range shown in the curves for different settings. The various specifications and guarantees assume that the appropriate LO band is used. The ALC loop includes a bias limit circuit to prevent overdrive when operated at an inappropriate LO frequency. LO TUNE1 and LO TUNE2 can be driven dynamically by using external control logic or can be set to Vcc or ground by using a  $0\Omega$  resistor on the pins. If driven from external logic,  $V_{CC}$  must be applied to the device so as to not overcurrent the on-chip ESD diodes which could damage the part. The LO TUNE1 and LO TUNE2 inputs have an internal 50kΩ pulldown resistor which can be used to set a logic-low if left unconnected.

#### Table 1. Channel Enable/Disable States

Main Channel	Diversity Channel	PD1	PD2
ON	ON	0	0
OFF	OFF	1	0
ON	OFF	0	1
OFF	ON	1	1

#### **Table 2. LO TUNE States**

Desired LO Band	LO_TUNE1	LO_TUNE2
< 2000MHz	0	1
≥ 2000MHz to < 2200MHz	0	0
≥ 2200MHz to 2400MHz	1	1
> 2400MHz	1	0

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#### **Bias Settings**

Since mixer linearity and power are affected by the device's operating points, flexibility was built into the MAX19757 so that the IF and LO bias levels can be adjusted using external resistor sets (see the *Typical Application Circuit*). Customized tradeoffs can thus be made to optimize linearity vs. overall power consumption. The IF quiescent bias is set via the current at pin 35 (the R1 value to ground), and the internal LO drive amplitude by the current at pin 29.

#### **IF Amplifier Bias Adjustments**

Pin 35 of the device, IF\_RADJ, must have a resistor to ground for the IF amp to function. A nominal IF bias of 80mA is obtained with a  $4.87k\Omega$  resistor used for R1. A smaller resistance increases the IF bias. Conversely, a larger resistance decreases the IF quiescent bias; the IF amp bias current through L1/L2 or L4/L5 of the <u>Typical</u> Application Circuit should not exceed 130mA.

#### LO Buffer Bias Adjustments

The internal LO target amplitude can be altered by sinking or sourcing sink current at the LO\_VADJ pin. To **increase** the static LO drive, remove R3 from V<sub>CC</sub> and connect it to ground. The value of R3 should be greater than 10K $\Omega$  for this increased drive operation. To reduce overall power consumption by **decreasing** the LO drive, connect R3 from pin 29 to V<sub>CC</sub>. The <u>Typical Application Circuit</u> is configured for this reduced power consumption mode.

#### **Static Bias Operation**

As outlined above, external resistor sets can be chosen to set the bias schemes for the MAX19757's LO and IF amplifier circuits. Select R1 and R3 to set the IF and LO biases per the guidance provided above. See the <u>Typical</u> <u>Application Circuit</u> for details surrounding the suggested configurations.

Using the static bias mode will ensure that the mixer delivers a constant level of linearity performance with a constant level of power dissipation, regardless of the signal power present on the mixer's RF ports.

#### **Dynamic Bias Operation**

The *static* biasing schemes outlined above provide a constant level of linearity for a given current draw. However, in many base station receiver applications, it may not be necessary to maintain exceptionally high levels of linearity performance at all times. IIP3 linearity is critical for base station receivers when the radio is operating in the presence of interfering blockers. Due to the intermittent nature of these blocking signals, there exists an opportunity to relax the mixer's IIP3 performance when the blockers are not present. This relaxation of linearity implies that the mixer's overall current consumption can be throttled back by a commensurate amount.

The MAX19757 capitalizes on this opportunity by employing a novel dynamic biasing scheme which detects the presence of blockers in the IF domain, and increases the biases to the IF and LO amplifiers automatically. The use of the feature is completely optional (see <u>Optional</u> <u>Dynamic Bias Typical Application Circuit</u>). In this figure, a few additional components and connections are added or modified to enable this feature. Omitting these additional components will force the circuit to revert back to the *static* biasing scheme.

The MAX19757 includes a simple log amp detector that senses the presence of a high-level signal on both of the IF paths. **IF\_DET\_OUT** (pin 11) will yield a signal that swings above or below the internal 1.2V bandgap reference and can therefore be used to source or sink current into the IF and/or LO bias adjust pins. As the IF signal *increases*, the IF\_DET\_OUT output decreases down to its 0.4V limit. Conversely, as the IF signal *decreases*, the IF\_DET\_OUT output increases to its upper limit of 1.7V. The nominal bias crossing corresponds to an IF output level of approximately +10dBm.

The **IF\_DET CEXT** pin (17) is used to set the attack / decay times of the detector. The effective resistance at this pin is ~  $30K\Omega$ . Select a Cext value appropriate for the slowest system data rate.

Typical values for dynamic control of both the IF and LO are as follows: **R1 = 4.64K**, **R2 = 5K**, **R3 = 10K**, **and Cext = 1µF**. Under small-signal conditions, the chip power will decrease ~25% and increase to about +30% with an IIP3 increase of ~3dBm.

Note that the attack/decay times will be affected when the individual paths are subjected to the shutdown states described in Table 1. Contact the factory for details.

#### Layout Considerations

A properly designed PCB is an essential part of any RF/ microwave circuit. Keep RF signal lines as short as possible to reduce losses, radiation, and inductance. For best performance, route the ground-pin traces directly to the exposed pad underneath the package. This pad **MUST** be connected to the ground plane of the board by using multiple vias under the device to provide the best RF and thermal conduction path. Solder the exposed pad on the bottom of the device package to a PCB.

#### **Power-Supply Bypassing**

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Proper voltage-supply bypassing is essential for high frequency circuit stability. Bypass each VCC pin with capacitors placed as close as possible to the device. Place the smallest capacitor closest to the device. See the <u>Typical</u> <u>Application Circuit</u> and <u>Table 3</u> for details.

# Table 3. Typical Application CircuitComponent Values

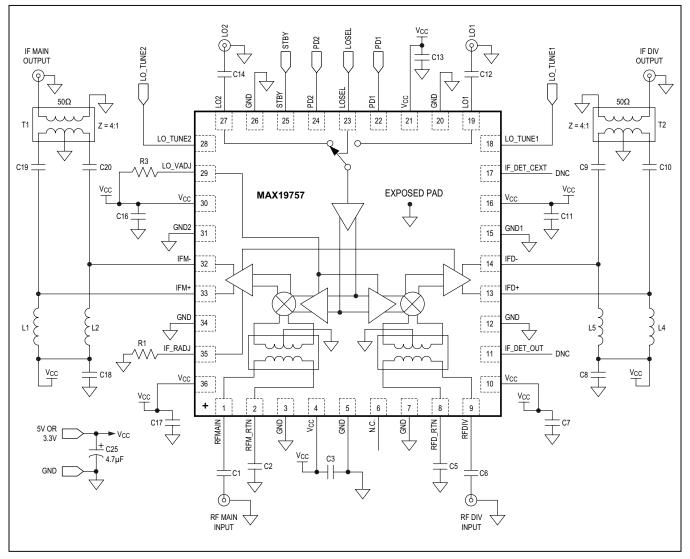
DESIGNATION	QTY	DESCRIPTION
C1, C6	2	3.0pF ±0.1pF 50V C0G CER CAP (0402) Murata: GRM1555C1H3R0B
C12, C14	2	5.0pF ±0.1pF 50V C0G CER CAP (0402) Murata: GRM1555C1H5R0B
C2, C3, C5, C7–C11, C13, C16–C20	14	0.01µF ±10% 25V X7R CER CAP (0402) Murata: GRM155R71E103K
C25	1	4.7µF ±10% 16V X7R CER CAP (1206) Murata: GRM31CR71C475K
L1, L2, L4, L5	4	330 nH ±5% Wire Wound IND (0805) Coilcraft: 0805CS-331XJLC
R1	1	4.87KΩ ±1% Resistor (0402) Any
R3	1	154KΩ ±1% Resistor (0402) Any
T1, T2	2	Mini Circuits TC4-1W-17
U1	1	Maxim MAX19757ETX+

# Exposed Pad RF and Thermal Considerations

The exposed pad (EP) of the device's 36-pin thin QFN package provides a low thermal-resistance path to the die. It is important that the PCB on which the IC is mounted be designed to conduct heat from this contact. In addition, provide the EP with a low-inductance RF ground path for the device. The EP **MUST** be soldered to a ground plane on the PCB, either directly or through an array of plated via holes. Soldering the pad to ground is also critical for efficient heat transfer. Use a solid ground plane wherever possible.

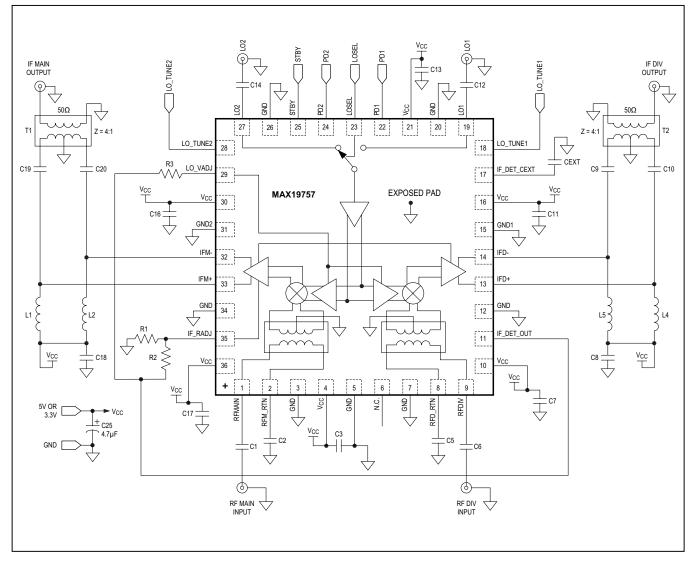
## Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

### **Typical Application Circuit**



### Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

### **Optional Dynamic Bias Typical Application Circuit**



# Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX19757ETX+	-40°C to +105°C	36 TQFN-EP*
MAX19757ETX+T	-40°C to +105°C	36 TQFN-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package.

\*EP = Exposed pad.

T = Tape and reel.

#### **Chip Information**

PROCESS: SiGe BiCMOS

#### **Package Information**

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
36 TQFN	T3666+2	<u>21-0141</u>	<u>90-0049</u>

# Dual, SiGe, High-Linearity, 1700MHz to 2700MHz Downconversion Mixer with Advanced Shutdown Features

#### **Revision History**

REVISION	REVISION	DESCRIPTION	PAGES
NUMBER	DATE		CHANGED
0	12/12	Initial release	—

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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